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## ENGINEERING MECHANICS: RESEARCH, M.S.

This is a named option within the Engineering Mechanics M.S. (http://guide.wisc.edu/graduate/mechanical-engineering/engineering-mechanics-ms/)

This program is broadly structured into several main areas of instruction and research interests in mechanics of materials and astronautics: continuum mechanics, computational mechanics, dynamics and vibration, fluid mechanics, nanomechanics, solid mechanics, and biomechanics. Related fields in which minor work may be done include civil and environmental engineering, chemical and biological engineering, electrical and computer engineering, materials science, mechanical engineering, nuclear engineering and engineering physics, physics, geological engineering and geology, mathematics, statistics, and computer science.

Current faculty research interests include adhesive-bonded joints; composites; failure criteria; analytical and computational solid mechanics; analytical and computational dynamics; multibody dynamics; analytical and computational active and passive space-structure control systems; dynamic stability; nonlinear fracture mechanics of traditional and advanced materials; continuum mechanics; modal analysis; nanomechanics and nanotribology; fluid-structure interaction; non-Newtonian fluid flow; structural mechanics; viscoelasticity; viscoplasticity; cell mechanics; and biomechanics.

Laboratories are well equipped for experimental testing and research; these include holography, Moire, atomic force microscopy, vibration testing, and other optical methods for experimental mechanics research. The department has access to collegewide facilities. The Wisconsin Laboratory for Structures and Materials Testing has facilities for testing large structures, fatigue and vibration labs, and complements the department's laboratories. The Materials Science Center provides state-of-the-art instrumentation, support facilities, and expert technical assistance for research and education in materials. Its facilities include scanning and transmission electron microscopes, image processing and analysis systems, surface and thin film characterization facilities, and x-ray diffraction facilities.

For more information on this specific degree plan, please see the ME website (https://engineering.wisc.edu/departments/mechanical-engineering/).